

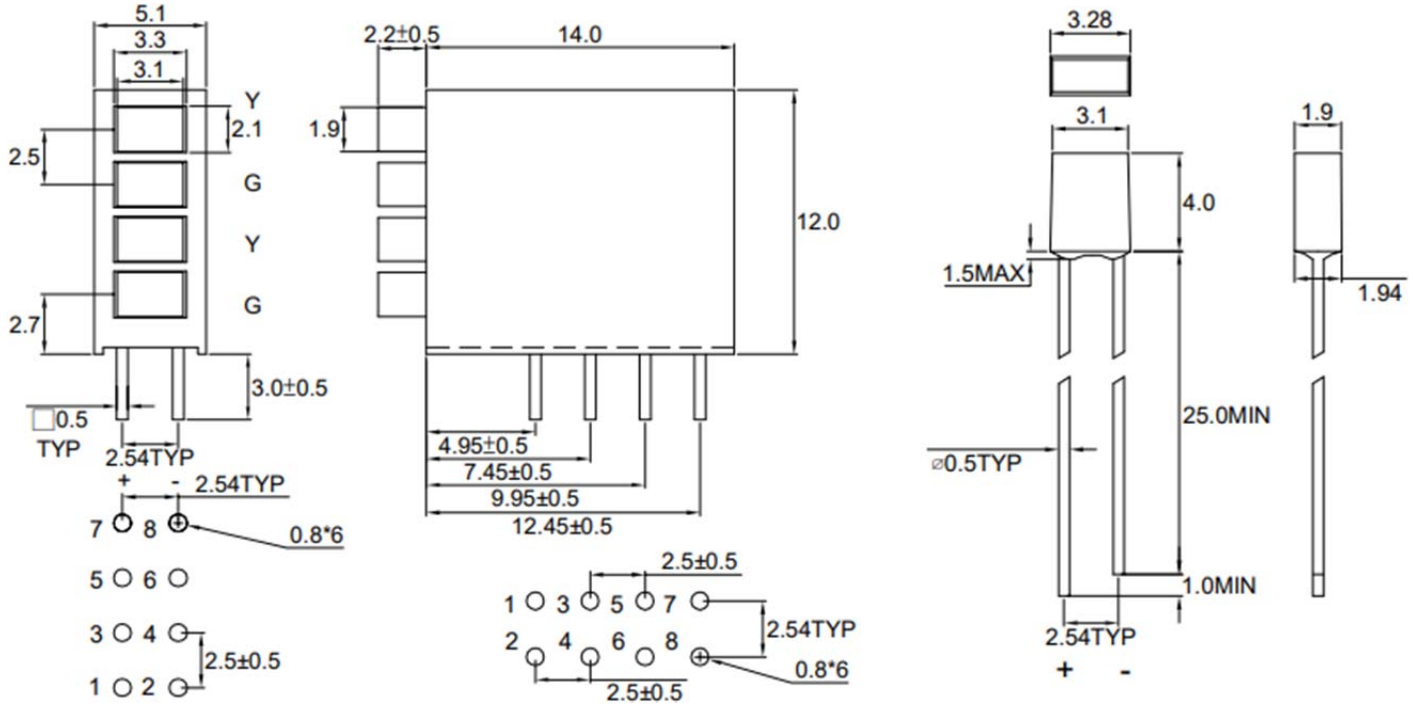


American Opto Plus LED Corp.

L3R4L-YGYGDH341

3mm Bi-Color Yellow and Green Square LED Lamp W/ Holder

PACKAGE DIMENSION



Notes:

1. All dimension are in millimeter tolerance is ± 0.25 mm unless otherwise noted.
2. Specifications are subject to change without notice.

Material	Color	
	Emitted	Lens
GaAsP/GaP	Yellow	Yellow Diffused
GaP	Green	Green Diffused



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ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

Parameter	Symbol	Value		Unit
		Y	G	
Forward Current	If	20	30	mA
Peak Forward Current Duty 1/10 @ 10KHz	Ifp	80	120	mA
Power Dissipation	Pd	60	100	mW
Reverse Current @ 5V	Ir	10	10	μA
Electrostatic Discharge	ESD	8000		V
Operating Temperature Range	Topr	-40~+85		°C
Storage Temperature Range	Tstg	-40~+100		°C

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol		Test Condition	Value			Unit
				Min	Typ	Max	
Luminous intensity	Iv	Y	IF = 10mA	8.0	20	--	mcd
		G		8.0	20	--	
Peak Wavelength	λP	Y	IF = 20mA	--	585	--	nm
		G		--	565	--	
Spectral Halfwidth	Δλ	Y		--	35	--	nm
		G		--	30	--	
Forward Voltage	Vf	Y		1.7	--	2.6	V
		G		1.7	--	2.6	
Viewing angle	2θ ½		--	138	--	Deg	

Notes:

1. The forward voltage data did not including ±0.1V testing tolerance.
2. The luminous intensity data did not including ±15% testing tolerance.



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LUMINOUS INTENSITY CLASSIFICATION

(IF=10mA)

Bin Code	Min	Max	Unit
A9	8	12	mcd
A10	12	20	
A11	20	30	
A12	30	45	
A13	45	65	



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ELECTRICAL-OPTICAL CHARACTERISTIC CURVES (YELLOW)

(Ta=25°C)

Fig.1 Forward current vs. Forward Voltage

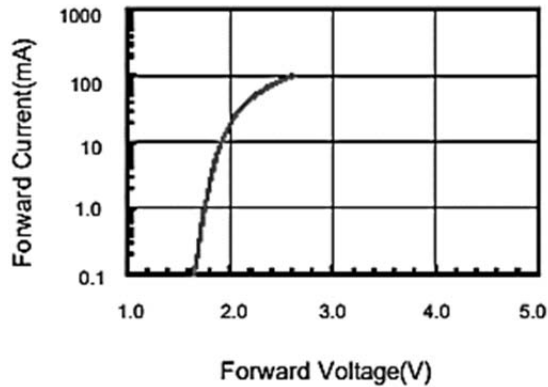


Fig.2 Relative Intensity vs. Forward Current

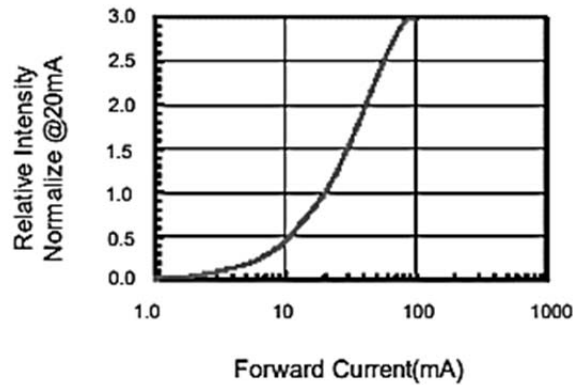


Fig.3 Forward Voltage vs. Temperature

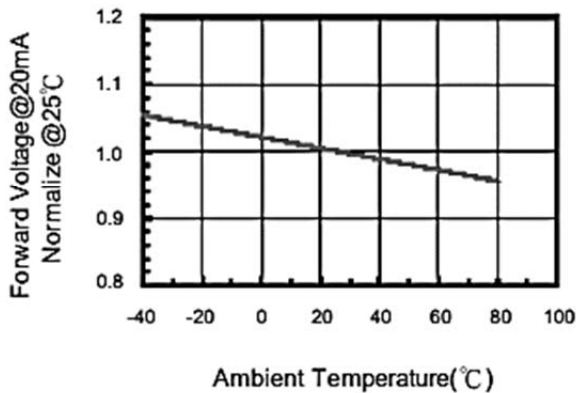


Fig.4 Relative Intensity vs. Temperature

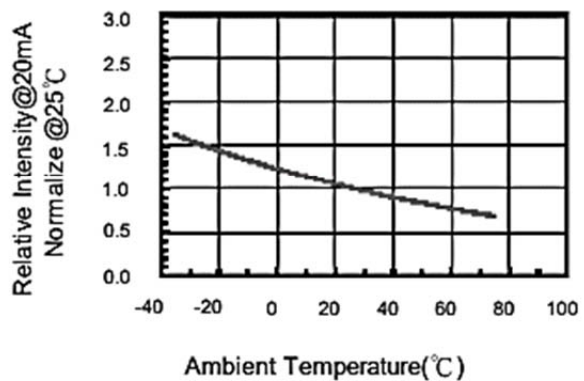
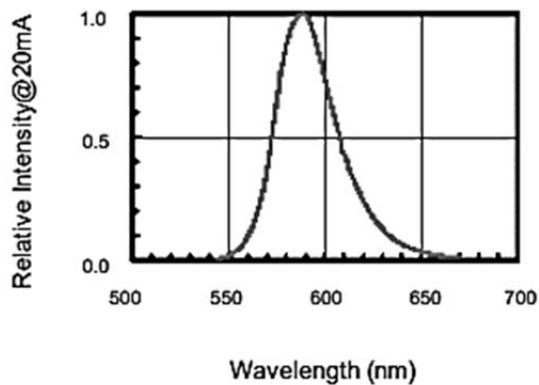


Fig.5 Relative Intensity vs. Wavelength





American Opto Plus LED Corp. L3R4L-YGYGDH341

3mm Bi-Color Yellow and Green Square LED Lamp W/ Holder

ELECTRICAL-OPTICAL CHARACTERISTIC CURVES (GREEN)

(Ta=25°C)

Fig.1 Forward current vs. Forward Voltage

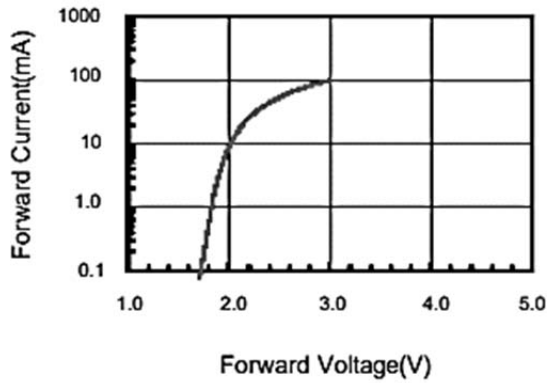


Fig.2 Relative Intensity vs. Forward Current

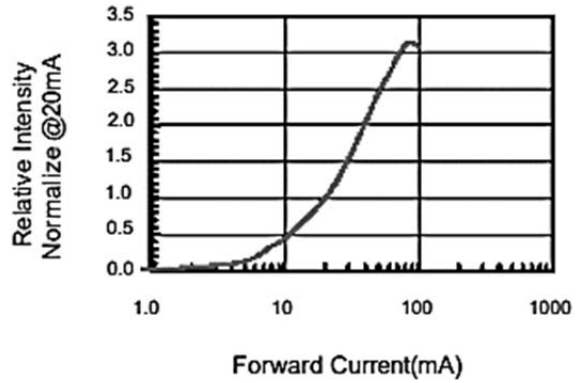


Fig.3 Forward Voltage vs. Temperature

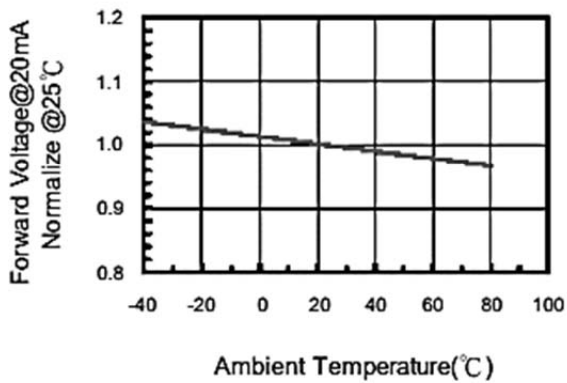


Fig.4 Relative Intensity vs. Temperature

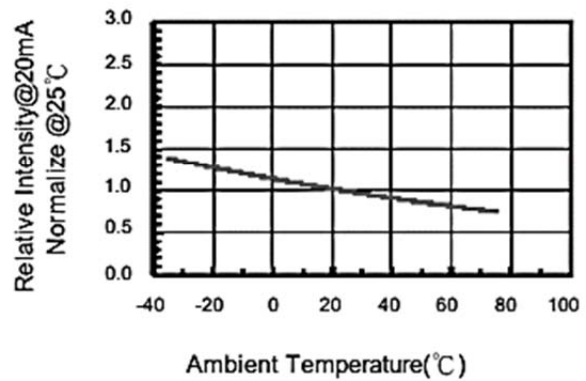
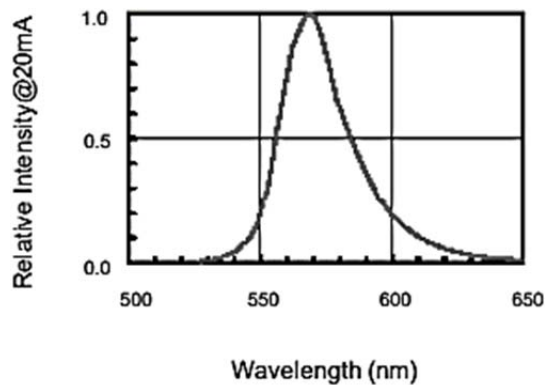


Fig.5 Relative Intensity vs. Wavelength





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RECOMMENDED SOLDERING CONDITIONS

1. Iron:

Soldering Iron: 30W Max

Temperature: 350°C Max

Soldering time: 3 Seconds Max (one time only)

Distance: 2mm Min (from solder joint body)

2. Wave Soldering Profile

Dip Soldering

Preheat: 120°C Max

Preheat Time: 60 Seconds Max

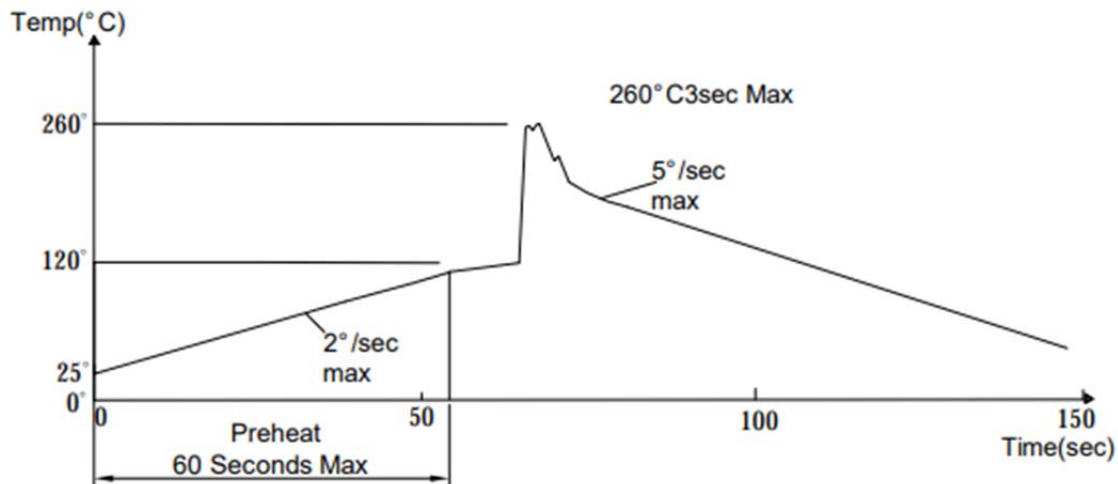
Ramp-up: 2°C/sec Max

Ramp-down: -5°C/sec Max

Solder Bath: 260°C Max

Dipping Time: 3 Seconds Max

Distance: 2mm Min (from solder joint body)





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RELIABILITY TEST

Test Item	Test Condition	Description	Reference Standard
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed.	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1
High Temperature Storage Test	1.Ta=105 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.	MIL-STD-883:1008 JIS C 7021: B-10
Low Temperature Storage Test	1.Ta=-40 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12
High Temperature High Humidity Test	1.Ta=65°C±5°C 2.RH=90 %~95% 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hours.	MIL-STD-202:103B JIS C 7021: B-11
Thermal Shock Test	1.Ta=105 °C±5°C&-40 °C±5°C (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011
Solder Resistance Test	1.T.Sol=260 °C±5°C 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1
Solderability Test	1.T.Sol=230 °C±5°C 2.Dwell time=5 ±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2